

Spartan 7 I/O OPTIMIZATION WITH THE HIGHEST PERFORMANCE-PER-WATT

UNMATCHED PERFORMANCE AND POWER EFFICIENCY AT THE LOWEST COST

If your power or performance requirements are just as challenging as your cost, look to Spartan®-7 FPGAs. Manufactured with TSMC's 28nm HPL process, this family brings together the extensive capabilities of the Xilinx 7 series FPGA architecture with small form factor and RoHS-compliant packaging for the most optimized connectivity solution in the 7 series portfolio. The efficient 7 series CLB architecture, enhanced DSP, and block RAM enable a roughly 50% power reduction vs. previous Spartan families, while at the same time deliver a 30% performance improvement. The MicroBlaze[™] 32-bit RISC processor delivers 200DMIPs of processing power on a Spartan-7 device. Spartan-7 devices enable key connectivity and processing applications in industrial, automotive, infotainment, consumer, and communications markets, among others.

INDUSTRY-LEADING TOOL AND IP SUPPORT WITH THE VIVADO DESIGN SUITE

Get a jump-start generating correct-by-construction block-level design by leveraging the vast catalog of over 200 available 7 series IP solutions in the Vivado® Design Suite IP Integrator. For fast deployment of the MicroBlaze processor, presets are available for Microcontroller, Real-Time Processor, and Application Processor use cases. Start with a preset, then further customize specific processor features to meet the specific needs of your application. Then expand your MicroBlaze processor system using drag n' drop IP from a catalog of driver-enabled peripherals such as PWMs, UARTs, serial interfaces, etc. Achieve timing closure faster and attain up to 20% higher utilization using the Vivado Design Suite's expert place and route technology. Verify your design with less hassle using the mixed-language simulator with no code line limits, at no extra cost. The MicroBlaze processor, drag n' drop peripherals, Vivado(R) HLx Design Suite WebPACK™edition, and Eclipse-based Software Development Kit are all available at no cost from Xilinx, allowing you to use the fastest and lowest-cost design tools for these devices.

PART OF THE BROADEST ALL PROGRAMMABLE COST-OPTI-MIZED PORTFOLIO

The Spartan-7 family complements Artix®-7 FPGAs and Zynq®-7000 All Programmable SoCs to introduce a new, lower-cost entry point into the Xilinx 7 series portfolio, delivering the best value for its target applications.

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The Challenge: Driving Down Size and Cost while Increasing Performance and Monitoring

> System requirements necessitate higher performance for any-to-any connectivity and sensor fusion

> Systems are required to meet smaller power budgets with less power support circuitry

 Form factor is continuing to shrink in order to meet more challenging mechanical requirements
 The onset of ubiquitous network connectivity

demands increased security and monitoring

The Solution: Spartan-7 FPGAs

> Industry-leading performance-per-watt at the lowest cost; half the power of previous devices with 30% more performance

> 200DMIPs of processing power, plus drag n' drop peripherals with MicroBlaze soft processor

 Cost efficient connectivity solution for both legacy and cutting-edge interfaces

 RoHS 6/6 compliant packaging options as small as 8mm

> Comprehensive device security and

environmental monitoring

> Scalable across the industries broadest

All Programmable Cost-Optimized Portfolio

 > Q temperature grade (-40°C to +125°C) on all commercial devices

KEY CAPABILITIES OVERVIEW

SPARTAN 7

Half the Power with Increased Performance

- > Half the total power of the previous Spartan family
- > Sub-watt performance ranging from 6K 102K logic cells
- > Lowest-power industrial speed grade offering (-1LI)
- > 30% faster logic performance than the previous generation Spartan family
- > A smart mix of logic resources with capacity of up to 102K logic cells for high-performance systems
- > Enhanced DSP block provides up to 176GMACs at 551MHz
- > 200DMIPs MicroBlaze processor in Microcontroller, Real Time Processor, or Application Processor configuration
- > Wide temperature grade offering allows -40°C to +125°C on commercial devices

Any-to-Any Connectivity

- > Support for major single-ended and differential I/O standards
- > Connect faster with 1.25Gb/s differential I/O, and up to 240Gb/s max aggregate bandwidth
- > 800Mb/s DDR3 line rates and 25.6Gb/s peak bandwidth per memory controller
- > Connect at lower cost and with ultimate flexibility using the optimized, soft memory controller
- > Simplify high-bandwidth interfaces with multi-voltage, multi-standard high-performance SelectIO™ interface banks with 3.3V capability

Lowest Cost

> 28nm HPL process from TSMC with cost-optimized packaging and dedicated IP blocks like the XADC integrated dual analog-todigital converters, and voltage/thermal monitoring to help reduce overall BOM cost

Innovative Packaging

- > At 8mm, industry's smallest form factor package for a 28nm FPGA
- > Lowest cost packaging with simple breakout
- > RoHS 6/6 Compliant

Security and Monitoring

- > Device DNA serial number and eFUSE identifier
- > AES256 CBC Mode bitstream decryption & SHA-256 bitstream symmetric authentication
- > Tamper monitoring and responses
- > Integrated supply voltage and thermal monitoring

Industry's Best Tool Flow

- > Faster timing closure and up to 20% higher utilization using the Vivado Design Suites' expert place and route technology
- > Bare metal, freeRTOS, and Linux support for MicroBlaze processor with drag n' drop peripherals
- > 200+ available IP solutions in Vivado IP Integrator for correct-by-construction block-level design
- > Easier verification with Vivado's mixed-language simulator at no extra cost and with no code line limits
- > Spartan-7 production devices supported by the free Vivado HL WebPACK Edition. Download at www.xilinx.com/vivado

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EATURES	OVFR\	/IFW

28nm TSMC HPL Process Technology Delivering best-in-class performance-per-watt	 Scalable 7 series CLB architecture Flexible LUTs are configurable as logic, distributed RAM, or shift registers From 6K – 102K logic cells for system-level integration
Low Cost by Design Cost-optimized, 7 series-based architecture	 Multiple efficient integrated blocks for BOM cost reduction, including XADC dual 12-bit analog-to-digital converters with supply voltage and thermal monitoring Optimized selection of I/O standards
Embedded Processing Faster embedded processing with MicroBlaze soft processor	> 200+ DMIPs MicroBlaze processor in Microcontroller, Real Time Processor, or Application Processor configuration
Integrated Memory Block Capacity up to 4.2Mb Block RAM with tremendous flexibility	 Efficient and high-performance block RAM with byte write enables and optional FIFO configuration 36K blocks can be split into two independent 18K block RAMs
Soft Memory Controller Efficient soft memory controller for the ultimate flexibility	 > DDR3/DDR2/LPDDR2 support > Data rates up to 800Mb/s (25.6Gb/s peak bandwidth) > Ultimate pinout flexibility > Software wizard to guide through the entire process
SelectIO Interface Technology Multi-voltage, multi-standard SelectIO interface banks	 > Up to 1.25Gb/s LVDS data rate, with up to 240Gb/s aggregate bandwidth > 3.3V to 1.2V I/O standards and protocols > HSTL and SSTL memory interfaces > Adjustable slew rates for added signal integrity
Efficient DSP48E1 Slices Drive high-performance arithmetic and signal processing	 Each slice contains a fast 18x25 wide multiplier with 48-bit accumulator and 25-bit pre-add Capable of up to 176GMACs at 551MHz Pipelining, balancing, cascading, SIMD support, integrated pattern detect, and ALU
Extensive Design Security Reduce system cost, increase reliability, and safeguard your design	 Device DNA serial number and eFUSE identifier AES256 decryption and SHA-256 authentication for bitstream Tamper monitoring and response
Small, RoHS 6/6 Compliant Packaging Flexible and cost-optimized for challenging mechanical requirements	 > 8mm - 27mm package footprints at 0.5mm - 1mm pitch > Extensive footprint-compatible package migration

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